Thin Film WBR (Wire Bond Resistor)

Top Contact





GENERAL DESCRIPTION

Top Contact Precision wire bondable resistors are ultra-stable with high reliability. Resistors are laser trimmed to tight tolerance. Customizable value and unique marking of that value. This device is built in 0202 chip outline and is ideal for but not limited to hybrid circuit applications.

These are designed specifically for applications that require thermo-compression, epoxy or ultra-sonic attachment.

APPLICATIONS

- Medical Implantable
- Military / Defense
- . Hybrid Designs
- . Multi-Chip Module (MCM)
- **Test & Measurement Instrumentation** •
- . High-Rel Microelectronics
- RF / Microwave communications

BENEFITS

- · Top Contact/ Bottom Isolated
- Ultra High Stability
- · High Reliability
- Extremely Tight Tolerance •
- Unique Value Marking •
- . 250 mW Power Rating
- Small package size •

HOW TO ORDER





Tolerance

supply design or

contact factory

(0.51



Termination Code G = Bondable Gold A = Aluminum

> 0.003 (0.05)

0.004 (0.10)

G

Packaging W = Waffle Pack

W

MECHANICAL DIMENSIONS INCHES (MM)

Size	Length (L)	Width(W)	Minimum Bond Area
0202	0.020 ± 0.003	0.020 ± 0.003	0.0038 ± 0.0038
	(0.51 ± 0.076)	(0.51 ± 0.076)	(0.09 x 0.09)

Other sizes available upon request

GENERAL CHARACTERISTICS

Operating Temperature	-55°C ± 125°C
Insulation Resistance	10ºMOhm

STANDARD VALUES

Part Number	Value (ohm)
WBR0202SD1R001FGW	10Ω
WBR0202SD2R001FGW	20Ω
WBR0202SD4R701FGW	47Ω
WBR0202SD1R002FGW	100Ω
WBR0202SD1R302FGW	130Ω
WBR0202SD2R202FGW	220Ω
WBR0202SD3R302FGW	330Ω
WBR0202SD6R802FGW	680Ω
WBR0202SD1R003FGW	1kΩ
WBR0202SD3R013FGW	3.01kΩ
WBR0202SD4R703FGW	4.7kΩ
WBR0202SD5R003FGW	5kΩ
WBR0202SD1R004FGW	10kΩ
WBR0202SD1R005FGW	100kΩ
WBR0202SD1R006FGW	1MΩ
WBR0202SD1R007FGW	10MΩ

Custom values available from 1 to 10M Ohm available upon request

ENVIRONMENTAL TESTS

Test	Limits	Specification
Life Test/ Stability	±0.25% Max Δ R/R	MIL-STD-202 MTD 108, 1000hrs, 125°C,50mW
Thermal Shock	±0.25% Max Δ R/R	MIL-STD-202 MTD 107
High Temperature Exposure	±0.25% Max Δ R/R	100 Hrs @ 150°C
Moisture Resistance	±0.25% Max Δ R/R	MIL-STD-202 MTD 106
Wire Bond Test	4 Gram Min (1.25 Mil Wire)	MIL -PRF-55342
Short Time Overload	±0.25% Max Δ R/R	MIL - PRF-55342

Not standard values, values shown for intruction purposes only

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